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QT-Brightek Optocoupler Series

ZERO-PHASE TRIAC OPTOCOUPLER

Part No.: QTM303X/ QTM304X/ QTM306X/ QTM308X series



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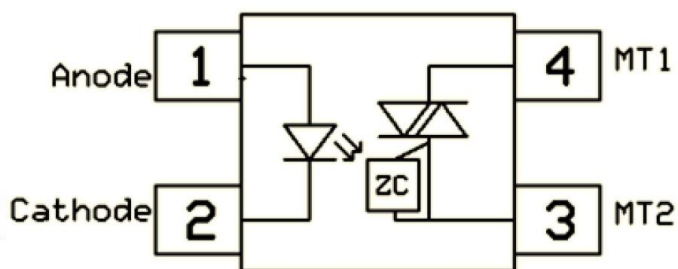
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Introduction

Feature:

- High Isolation voltage between input and output (Viso = 3750V rms)
- Peak Breakdown Voltage
 - 250V – QTM3031, 3032, 3033
 - 400V – QTM3041, 30422, 3043
 - 600V – QTM3061, 3062, 3063
 - 800V – QTM3081, 3082, 3083
- Operating Temperature up to 100 °C

Schematic:

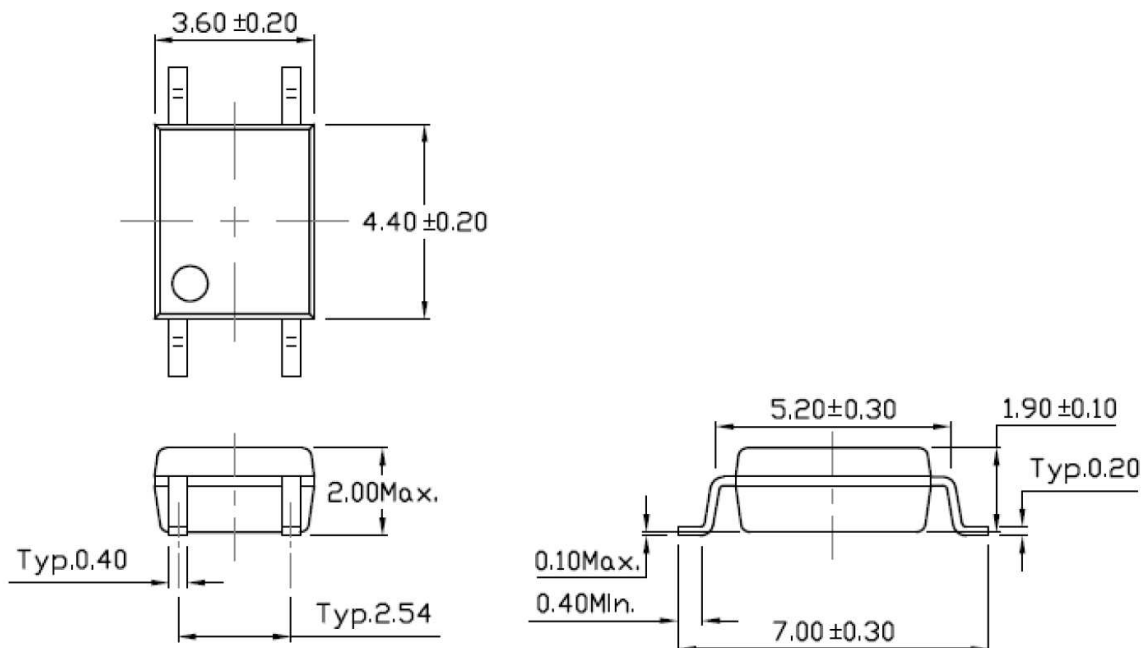


Certification & Compliance:

- Pb free and RoHS Compliant
- UL recognized (File #E338132)
- VDE (Pending Approval)



Dimension: (Dot location indicates pin 1)



All Dimensions are in mm

**Absolute Maximum Rating**

Symbol	Parameter	Rating			Units
		Q301X series	Q302X series	Q305X series	
T _{STG}	Storage Temperature	-55 ~ 150			°C
T _{OPR}	Operating Temperature	-55 ~ 100			°C
T _{SOL}	Lead Solder Temperature	260 for 10 sec			°C
P _{TOT}	Total Power Dissipation	200			mW
EMITTER					
I _F	Continuous Forward Current	60			mA
I _{FP}	Peak Forward Current (≤ 1us, 300pps)	1			A
V _R	Reverse Voltage	6			V
P _D	Power Dissipation	100			mW
DETECTOR					
P _D	Power Dissipation	300			mW
V _{DRM}	Off-state Output Terminal Voltage	Q303X series	250		V
		Q304X series	400		
		Q306X series	600		
		Q308X series	800		
I _{TSM}	Peak Repetitive Surge Current	1			A

**Electrical Characteristic (T_A=25 °C)****Emitter**

Symbol	Characteristic	Test Condition	Range			Unit
			Min	Typ	Max	
V _F	Forward Voltage	I _F = 10mA	-	-	1.5	V
I _R	Reverse Current	V _R = 6V	-	-	5	μA
C _{IN}	Input Capacitance	f = 1kHz	-	45	-	pF

Detector

Symbol	Characteristic	Device	Test Condition	Range			Unit
				Min	Typ	Max	
I _{DRM1}	Peak Blocking Current	QTM303X/ QTM304X Series	V _{DRM} = Rated V _{DRM} , I _F = 0mA	-	-	100	nA
		QTM306X/ QTM308X Series		-	-	500	
I _{DRM2}	Inhibit Leakage Current		I _F = Rated I _{FT} , V _{DRM} = Rated V _{DRM}	-	-	500	μA
V _{INH}	Inhibit Voltage		I _F = Rated I _{FT}	-	-	20	V
V _{TM}	Peak on-state voltage		I _{TM} = 100mA peak, I _F = Rated I _{FT}	-	-	3	V
dv/dt	Critical Rate of Rise off-state voltage	QTM303X series	V _{PEAK} = Rated V _{DRM} , I _F = 0 (refer to test circuit for dv/dt)	1000	-	-	V/ μs
		QTM304X series					
		QTM306X series					
		QTM308X series	V _{PEAK} = Rated V _{DRM} , I _F = 0 (refer to test circuit for dv/dt)	600	-	-	

**Transfer Characteristic**

Symbol	Characteristic	Device	Test Condition	Range			Unit
				Min	Typ	Max	
I _{FT}	LED Trigger Current	QTM3031	Main terminal voltage = 3V, I _{TM} =100mA	-	-	15	mA
		QTM3041		-	-		
		QTM3061		-	-		
		QTM3081		-	-		
		QTM3032		-	-	10	
		QTM3042		-	-		
		QTM3062		-	-		
		QTM3082		-	-		
		QTM3033		-	-	5	
		QTM3043		-	-		
		QTM3063		-	-		
		QTM3083		-	-		
I _H	Holding Current			-	250	-	μA
R _{IO}	Isolation Resistance		V _{IO} =500V _{DC}	1x10 ¹¹	-	-	Ω
C _{IO}	Isolation Capacitance		F=1MHz	-	0.25	-	pF

Characteristic Curves

QTM303X/ QTM304X

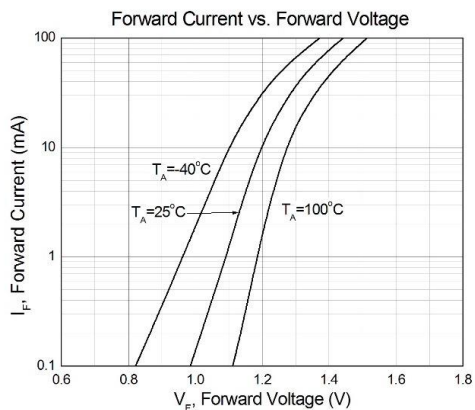


Figure 1

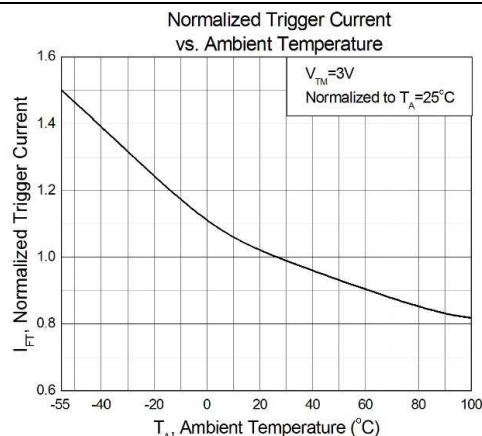


Figure 2

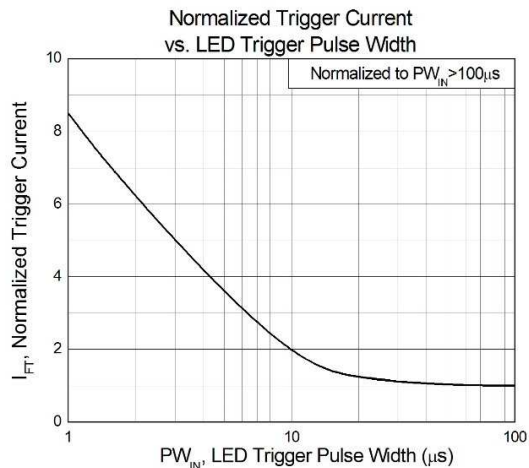


Figure 3

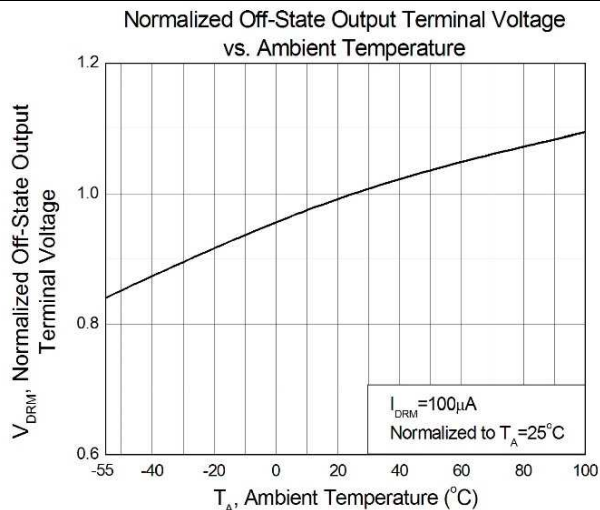


Figure 4

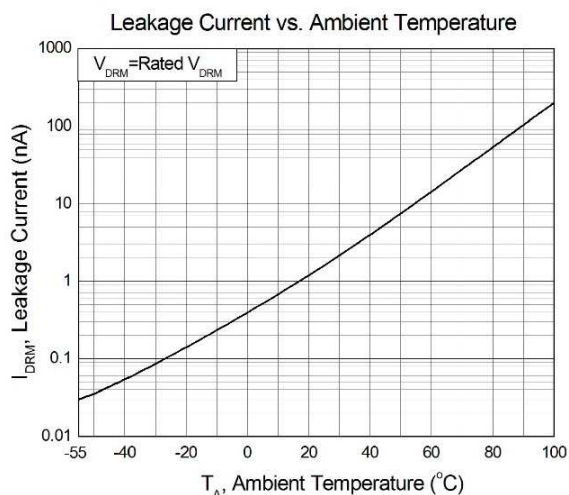


Figure 5

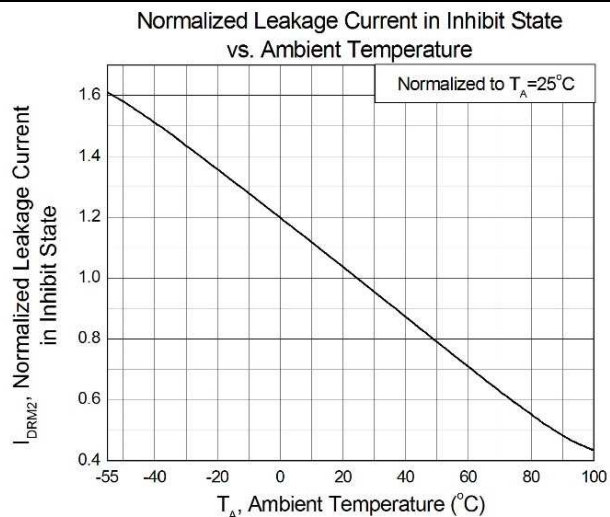


Figure 6

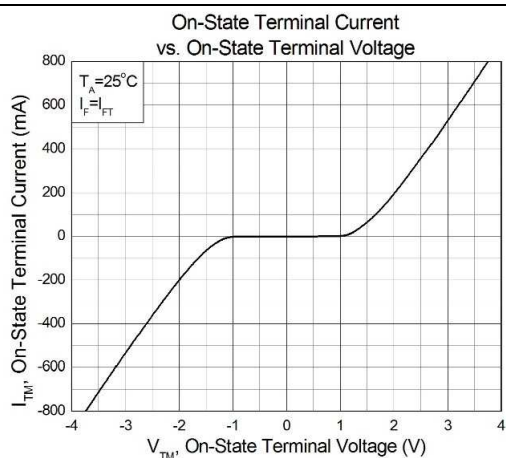


Figure 7

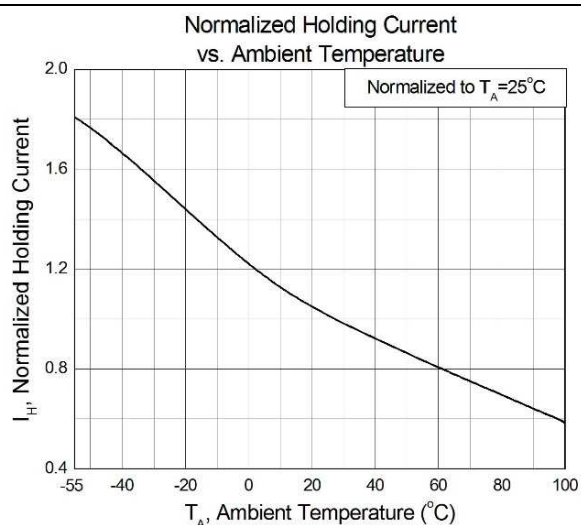


Figure 8

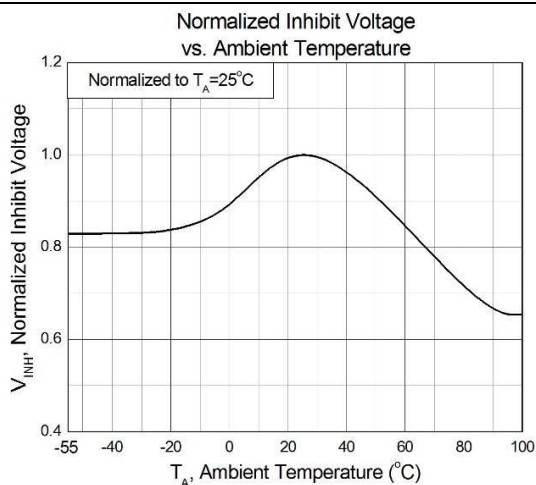


Figure 9

QTM306X/ QTM308X

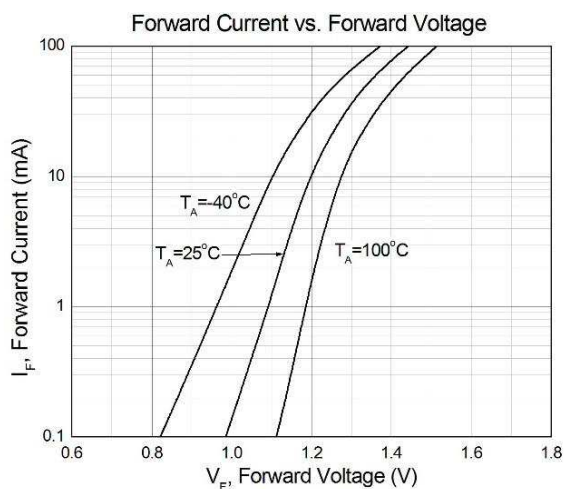


Figure 1

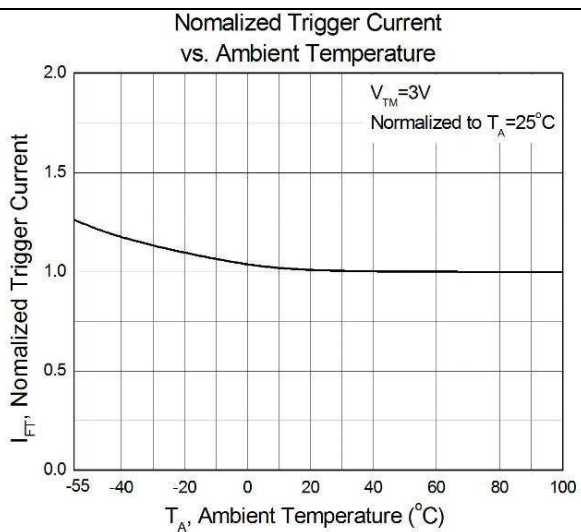


Figure 2

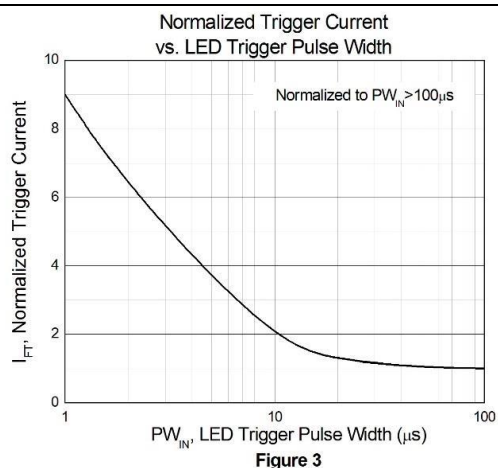


Figure 3

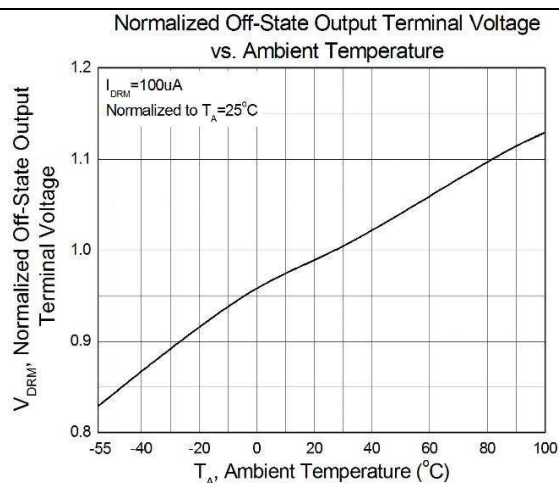


Figure 4

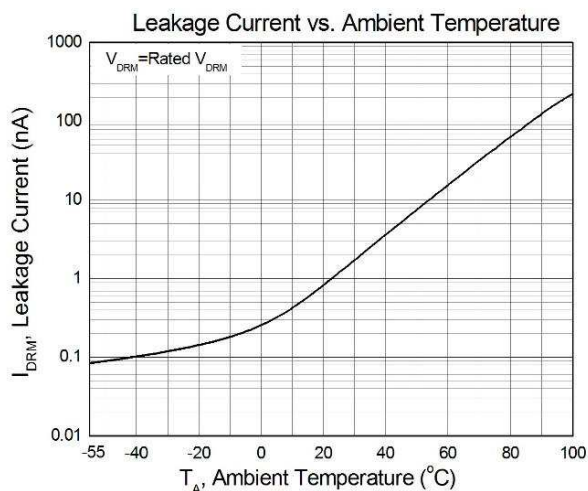


Figure 5

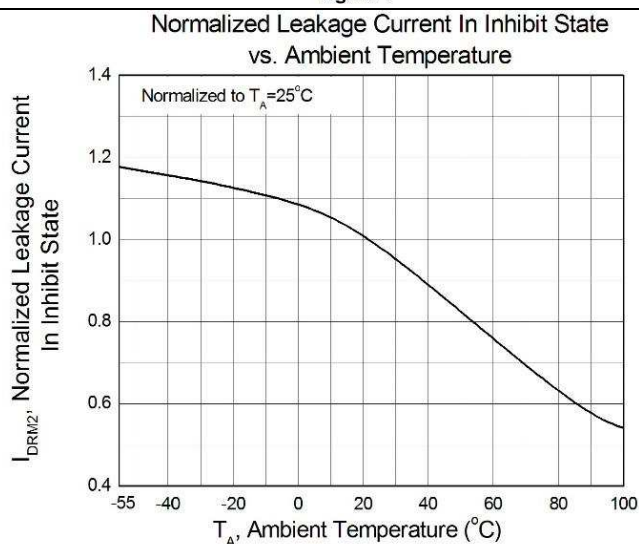


Figure 6

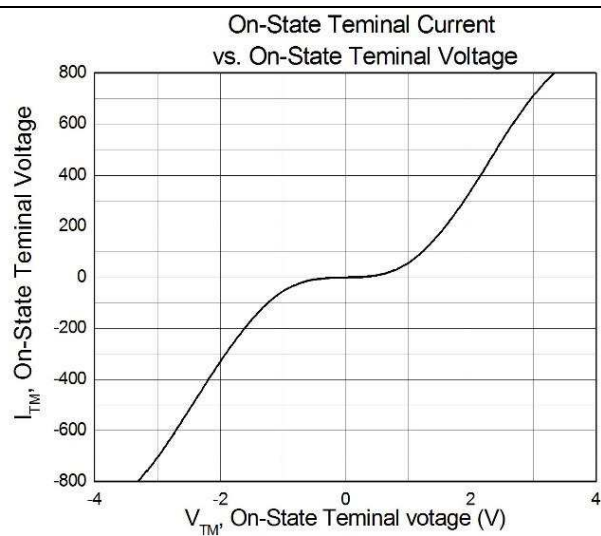


Figure 7

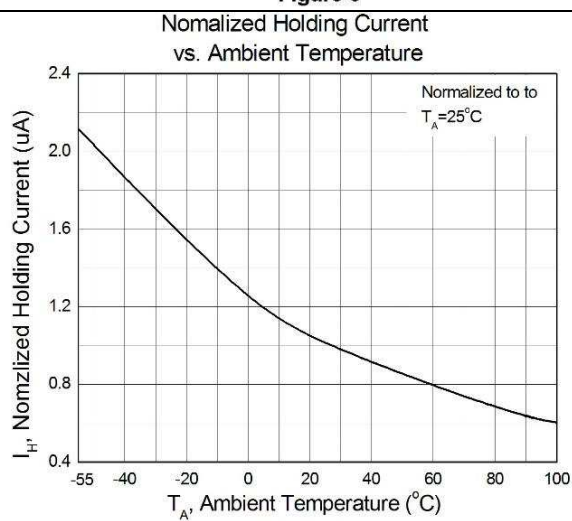
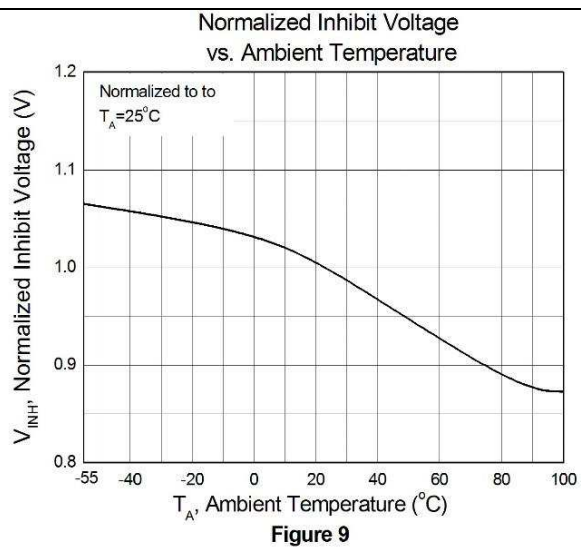
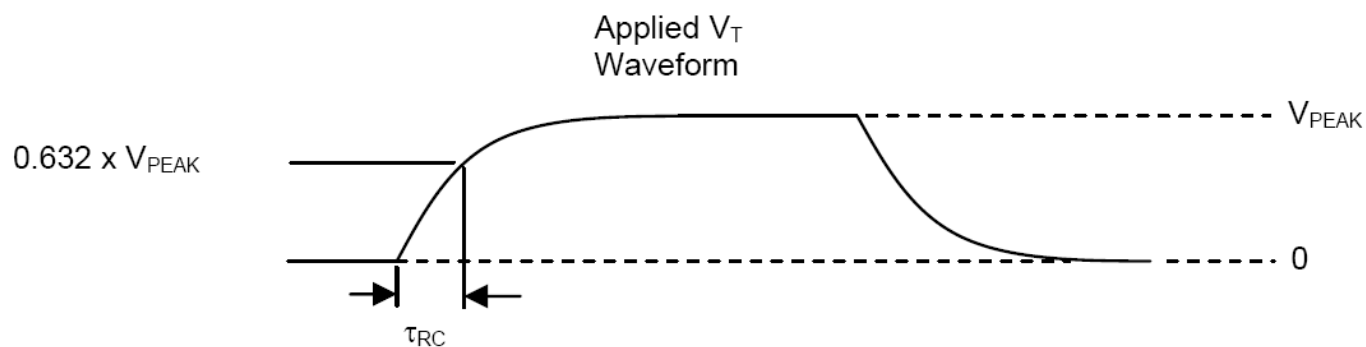
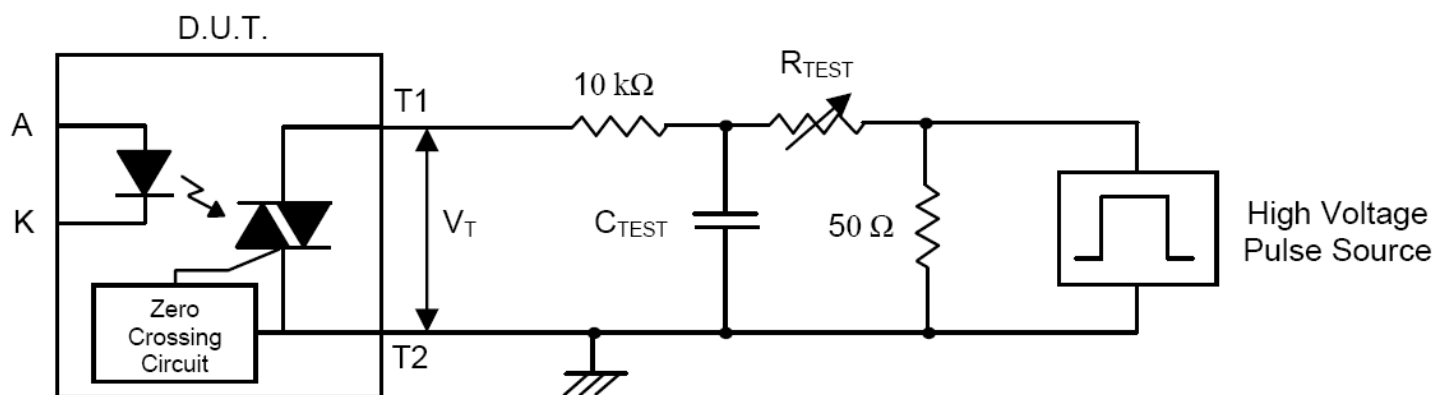


Figure 8



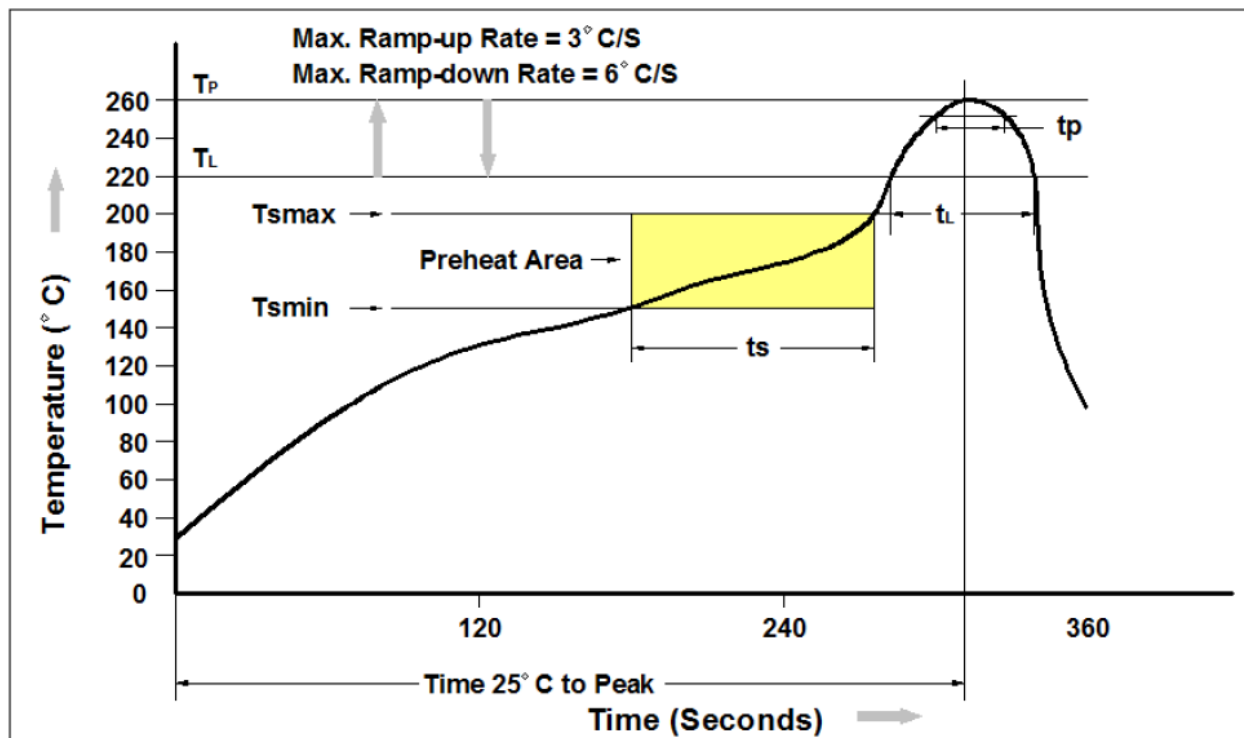
Test Circuit for static dv/dt



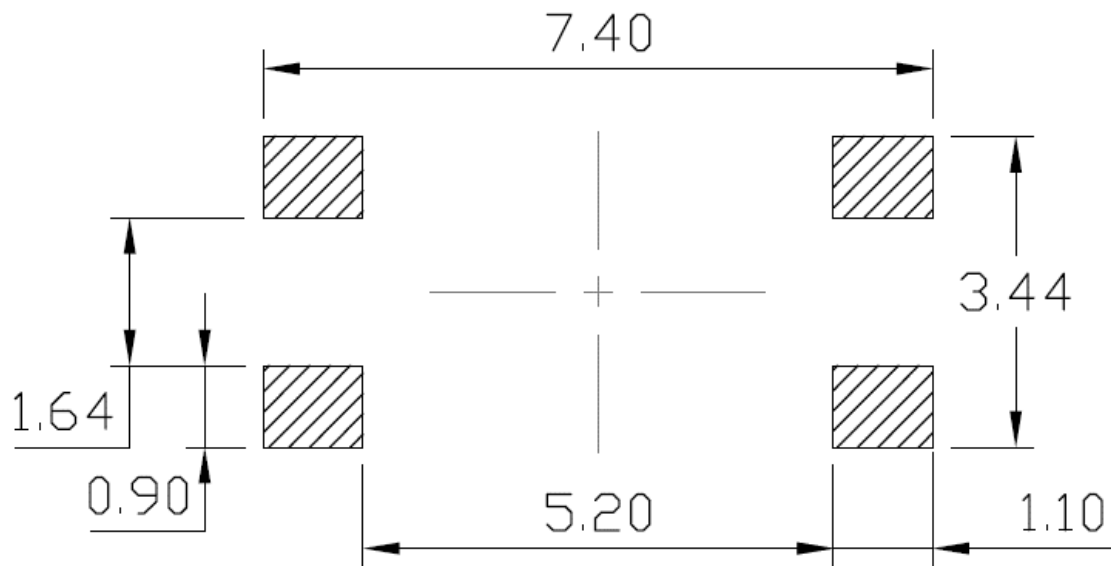
The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST} , the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

Solder Profile & Footprint



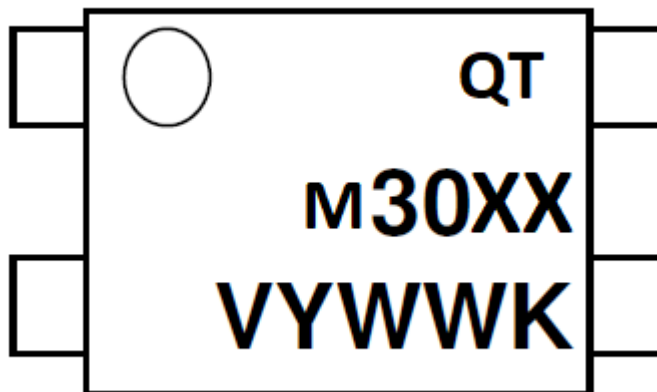
Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	150 °C
Temperature Max. (T _{smax})	200 °C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds
Ramp-up Rate (t _L to t _p)	3 °C/second max.
Liquidous Temperature (T _L)	217 °C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260 °C +0 °C / -5 °C
Time (t _p) within 5 °C of 260 °C	30 seconds
Ramp-down Rate (T _P to T _L)	6 °C/second max
Time 25 °C to Peak Temperature	8 minutes max.



Recommended Solder Footprint for SMD Leadform

Units: mm

tolerance: +/- 0.1mm

Device Marking:

QT = QT-Brightek Corporation
 M= Mini-Flat Package
 30XX = part number
 R= CTR Rank
 Y = Year
 WW = Week
 V = VDE Option
 K= Manufacturing code

Ordering Information

QTM30XX(V)(Z)

XX = Part number (X=31, 32, 33, 41, 42, 43, 61, 62, 63, 81, 82, or 83)

V = VDE option (V or None)

Z = Tape and reel option (T1 or T2)

Option	Description	Quantity
T1	Surface Mount Lead Forming – with Option 1 Taping	3000 pcs/ reel
T2	Surface Mount Lead Forming – with Option 2 Taping	3000 pcs/ reel



Revision History

Description:	Revision #	Revision Date
Initial of QTM302X /QTM304X/QTM306X/ QTM308X series	1.0	02/08/2018
Amend the Marking	1.1	04/12/2018

Disclaimer

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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